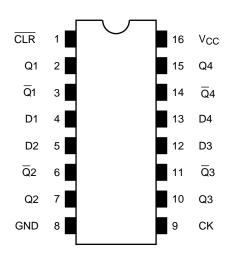
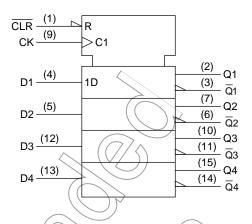
# Pin Assignment (top view)

# **IEC Logic Symbol**



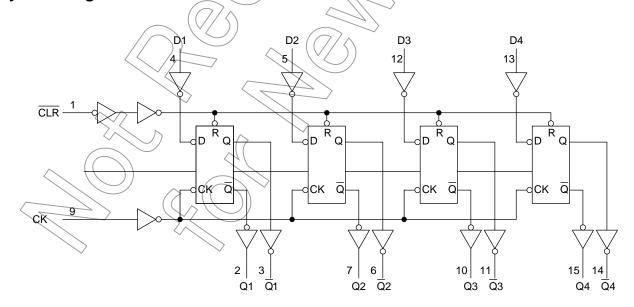


#### **Truth Table**

					\ \			
	Inputs		Outputs Function					
CLR	D	CK	Q	Ø(	Tunction			
L	Х	Х	L	TH.	Clear			
Н	L		L (	H				
Н	Н	Ļ	н	\\				
Н	X	$\vdash^{\downarrow}$	Ø <sub>p</sub>	$\overline{Q}_n$	No change			
		•	1 1	1 1				

X: Don't care

# **System Diagram**



#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V
DC output voltage	Vout	-0.5~V <sub>CC</sub> + 0.5	V
Input diode current	lık	-20	mA <
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA _
Power dissipation	PD	180	mW/
Storage temperature	T <sub>stg</sub>	-65~150	\c\_<

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Foshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e., reliability test report and estimated failure rate, etc).

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0~5.5	(47)
Input voltage	V <sub>IN</sub>	025.5	
Output voltage	V <sub>OUT</sub> <	0~V <sub>CC</sub>	\\V_
Operating temperature	T <sub>opr</sub>	-40~85	/ %c
Input rise and fall time	dt/dv	$0-100 \text{ (V}_{CC} = 3.3 \pm 0.3 \text{ V)}$ $0-20 \text{ (V}_{CC} = 5 \pm 0.5 \text{ V)}$	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics		Symbol	ymbol Fest Condition			Ta = 25°C			Ta = -40~85°C		Unit
		Symbol		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
	$\wedge \rangle$				2.0	1.50	_	_	1.50	_	V
la manda and the m	High level	V <sub>IH</sub>			3.0~5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	
Input voltage			9		2.0	1		0.50		0.50	V
	Low level V <sub>IL</sub>				3.0~5.5	ı	ı	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	
				2.0	1.9	2.0		1.9			
	High level V <sub>OH</sub>	VoH	OH Or VIL	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	
					4.5	4.4	4.5	_	4.4	_	
				$I_{OH} = -4 \text{ mA}$	3.0	2.58			2.48		
Output voltage				$I_{OH} = -8 \text{ mA}$	4.5	3.94	1	1	3.80		V
Output voltage					2.0		0	0.1		0.1	V
			., .,	$I_{OL}=50~\mu A$	3.0	1	0	0.1		0.1	-
	Low level	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$		4.5	1	0	0.1		0.1	
			0. 41	$I_{OL} = 4 \text{ mA}$	3.0		_	0.36	_	0.44	
				$I_{OL} = 8 \text{ mA}$	4.5		_	0.36		0.44	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0~5.5			±0.1	_	±1.0	μΑ
Quiescent supply	y current	Icc	$V_{IN} = V_{CC}$	or GND	5.5	_	_	4.0	_	40.0	μΑ

3

# Timing Requirements (Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40~85°C	Unit	
Characteristics	Symbol	rest Condition	V <sub>CC</sub> (V)	Тур.	Limit	Limit	O.III	
Minimum pulse width	t <sub>w (L)</sub>	_	$3.3 \pm 0.3$		5.0	5.0	ns	
(CK)	t <sub>w (H)</sub>		$5.0 \pm 0.5$		5.0	5.0	115	
Minimum pulse width	<b>t</b> (1)		$3.3 \pm 0.3$		5.0	5.0	ns	
(CLR)	t <sub>w (L)</sub>		$5.0 \pm 0.5$		5.0	5.0	115	
Minimum set-up time	t <sub>s</sub>		$3.3 \pm 0.3$	(	50)	5.0	ns	
Williman Sec-up time			5.0 ± 0.5	+	4.0	4.0	115	
Minimum hold time	t <sub>h</sub>		$3.3 \pm 0.3$		) <u>1</u> .0	1.0	ns	
Willim Hora time			$5.0 \pm 0(5($		1.0	1.0	113	
Minimum removal time	+		$3.3 \pm 0.3$	))	5.0	5.0	ns	
( CLR )	t <sub>rem</sub>		$5.0 \pm 0.5$	$\frac{1}{2}$	5.0	5.0	119	

#### AC Characteristics (Input: $t_r = t_f = 3$ ns)

	Q				Ta = 25°C			Ta=-4	11.7	
Characteristics	Symbol	Test Condition	V <sub>CQ</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	Unit
		Н	3.3 ± 0.3	15	_	7.5	11.5	1.0	13.5	
Propagation delay time	t <sub>pLH</sub>		3.5 \$ 0.5	<sup>→</sup> 50	- (	10.0 <	15.0	1.0	17.0	ns
(CK-Q)	tpHL	_ ((	5.0 ± 0.5	15		4.8	7.3	1.0	8.5	113
			3.0 1 0.3	50 (	_	6.3	9.3	1.0	10.5	
			$3.3 \pm 0.3$	15		6.3	10.1	1.0	12.0	
Propagation delay time	t <sub>pHL</sub>		3.3 ± 0.5	50		8.8	13.6	1.0	15.5	ns
(CLR -Q)		5.0 ± 0.5	15	_	4.3	6.4	1.0	7.5	113	
			0.0 ± 0.0	50	\ —	5.8	8.4	1.0	9.5	
	fmax		3.3 ± 0.3	15	90	140	_	75	_	
Maximum clock frequency				√ 50	50	75	_	45	_	MHz
Maximum crock frequency	Tillax_		5.0 ± 0.5	) 15	150	210	_	125	_	
	<u>~</u>		0,0 = 0.0	50	85	115	_	75	_	
Output to output skew	t <sub>osLH</sub>	(Note 1)	$3.3 \pm 0.3$	50	_	_	1.5	_	1.5	ns
	t <sub>osHL</sub>	(11010-1)	$5.0 \pm 0.5$	50	_	_	1.0	_	1.0	110
Input capacitance	C <sub>IN</sub>	-	_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)	_	44	_	_	_	pF

Note 1: Parameter guaranteed by design.

tosch = |tplHm - tplHn|, tosHL = |tpHLm - tpHLn|

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

4

Average operating current can be obtained by the equation:

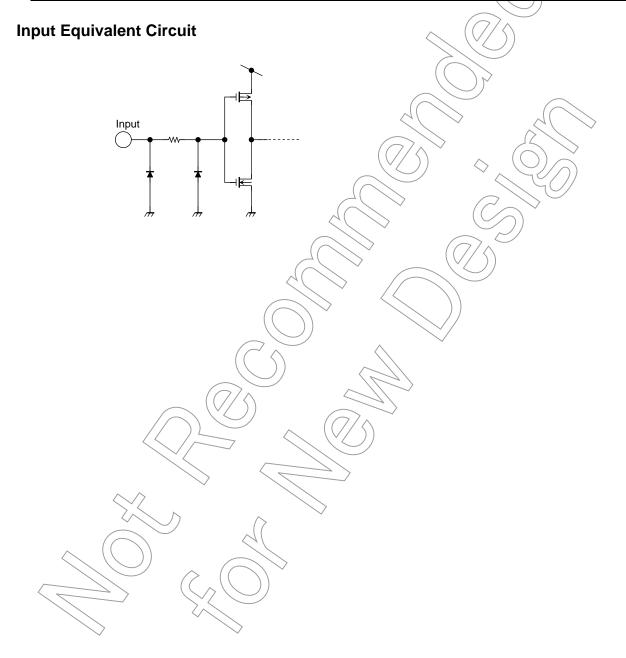
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per bit)}$ 

And the total CPD when n pcs of flip-flop operate can be gained by the following equation:

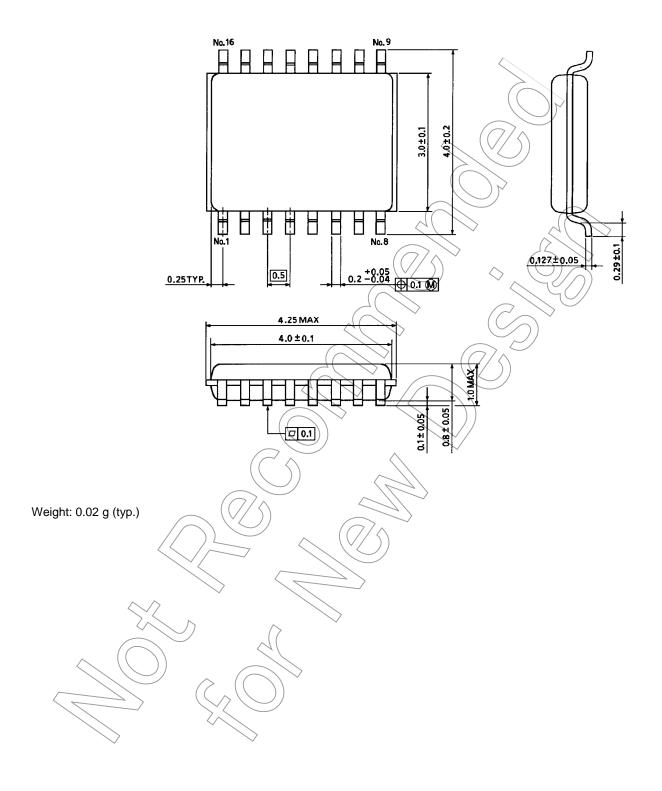
 $C_{PD}$  (total) = 30 + 14 · n

# Noise Characteristics (Input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Unit
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage $V_{\mbox{\scriptsize IH}}$	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0		3.5	V
Maximum low level dynamic input voltage $V_{\text{IL}}$	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	4	1.5	V



# **Package Dimensions**



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2007-10-19